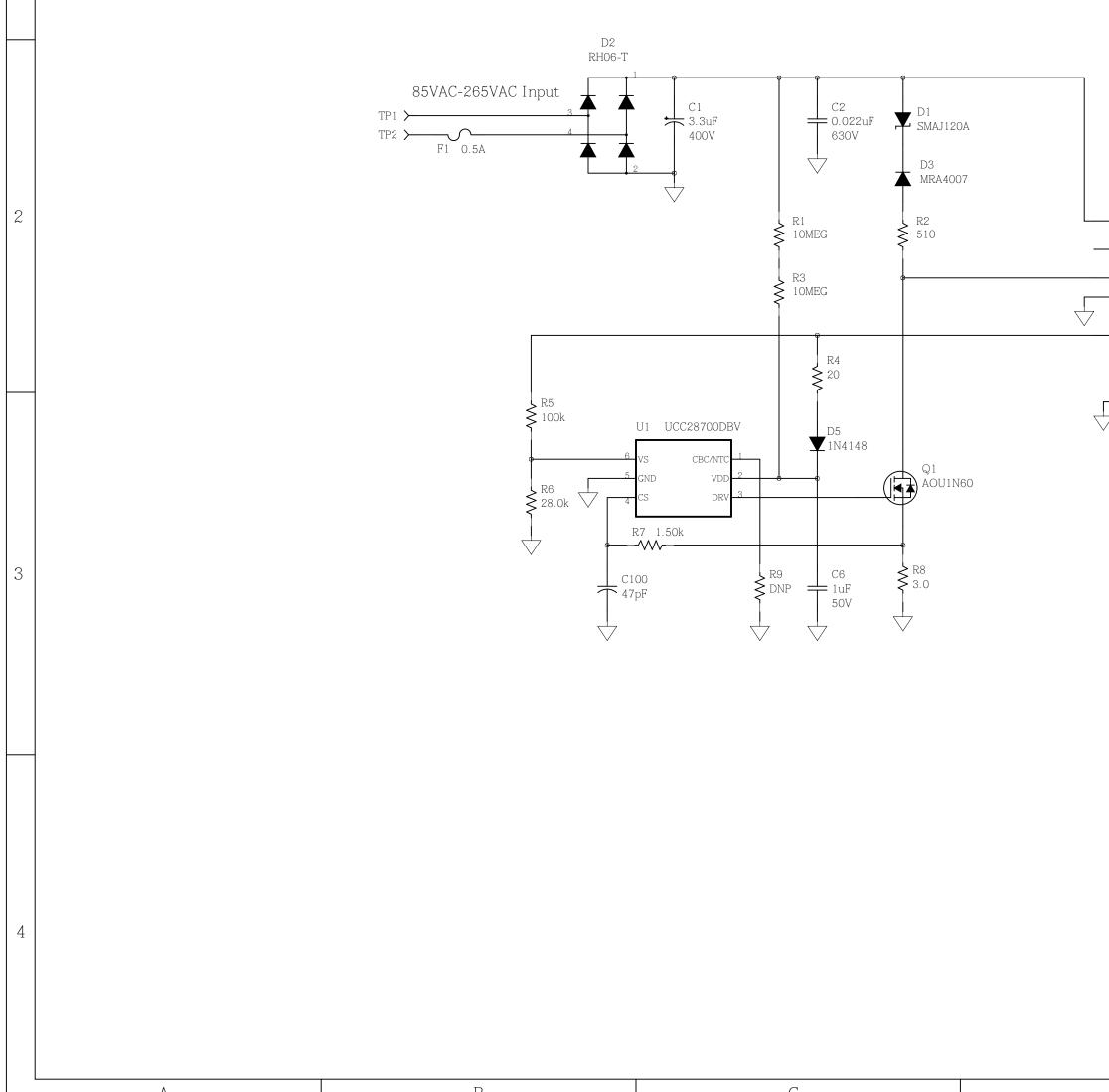
A	В	С	D	E	F
Notes: 1) Built on PMP8764 Rev A PCB.					
2) Reference designators >99 were add	led for PMP8869.				
1					1
	D2 RH06-T				
	85VAC-265VAC Input	C_1 C_2 C_3			
	TP2 \rightarrow F1 0.5A 4	$\begin{array}{c} C1 \\ 3.3\mathrm{uF} \\ 400\mathrm{V} \end{array}$			
	2	MRA4007	T2 3 1.8 mH		
2		$\begin{array}{c} R1 \\ 10MEG \end{array} \qquad \begin{array}{c} R2 \\ 510 \end{array}$			2
		R3 \$ 10MEG	516:2:3(Pri:S		
		Ê Î		ES1B	
		₹ ^{R4} 20	C101 220pF II	$\begin{array}{c c} R100 \\ 10k \\ \hline \\ 22uF \\ 25V \\ \hline \\ 180uF \\ 16V \\ \hline \\ 16V \\ \end{array}$	3W
	R5 100k	UCC28700DBV D5 1N4148		↓ ↓ ↓ TP4 	
	$\begin{array}{c} & & & & & \\ & & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & \\ & & & & \\ & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ &$	CBC/NTC D VDD 2 DRV 3 Q1 AOU1N60			
		1.50k			
3	$\begin{array}{c} & & & \\ & & & & \\ & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & & \\ & & & &$	DQ			3
	4/pH	$\begin{array}{c} 5 \\ 5 \\ \hline \end{array} \\ \hline \\ \\ \end{array} \\ \hline \\ \\ \\ \end{array} \\ \hline \\ \\ \\ \\$			
	v	· ·			
4				Title	Texas Instruments 4 Universal AC Input, 12V/3W Flyback
				Size	Number Rev PMP8869 B
				Date	07/11/2013 Drawn by B KING
A	В	С	D	ngineer B KING Filename	PMP8869_REVB.sch Sheet 1 of 1 F 7/11/2013 7/11/2013 F 7/11/2013 F F 7/11/2013 F



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